# **Electrical characterization of a Schottky diode based on organic semiconductor film**

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The organic Schottky diode of fluorescein sodium salt using aluminium and gold metals were fabricated. Electronic and interface state properties of the Al/p-FSS Schottky diode were investigated by current-voltage and capacitance-voltage analyses. The electronic parameters such as barrier height ( $\phi_b=0.72 \text{ eV}$ ), ideality factor (n=3.05) and series resistance (7.73 k $\square$ ) of the Schottky diode were determined by performing different plots. The  $\phi_b(C-V)$  value obtained capacitance-voltage measurements is 1.05 eV. The barrier height obtained from the C-V measurements is higher than that of obtained from the I-V measurements. The difference between  $\phi_b(I-V)$  and  $\phi_b(C-V)$  barrier height values can be due to interfacial layer, excess capacitance and barrier inhomogenity. The ideality factor confirms that the Al/p-FSS device is a metal insulator-semiconductor Schottky diode. The shape of the density distribution of the interface states is in the range of E<sub>SS</sub>-0.02 eV to E<sub>SS</sub>-1.21 eV.

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#### 1. Introduction

A large number of Schottky barriers have been prepared and characterized using organic conductive polymers with metals and inorganic semiconductors [1-3]. The fabrication and characterization of the Schottky diode barrier using organic semiconductors and their derivatives have been taken considerable attention in recent years [4-5]. Organic semiconductors can be used as activate components in electronic devices and these materials have potential advantages due to easily processable in low cost and large area device characterization. This has opened a new possibility of replacing conventional inorganic devices by the organic ones. The device performance of a Schottky diode depends on electrical and electronic characteristics of the metal/ organic semiconductor junction. Therefore, the understanding of electronic properties of the interface between metal and organic semiconductor is important for device applications.

In this study, Schottky barrier diode consisting of Al metal and fluorescein sodium salt organic semiconductor was fabricated. The electronic parameters controlling the device performance, such as barrier height, ideality factor, series resistance and interface parameters were evaluated by current-voltage and capacitance-voltage measurements.

#### 2. Experimental

p-Si was used as substrate. The substrate was rinsed in deionised water using an ultrasonic bath for 10-15 min and finally was chemically cleaned according to method based on successive baths of methanol and acetone. The substrate was placed in vacuum system for the processes.

High purity (99.999%) Al metal was thermally evaporated on the substrate. The solution of the fluorescein sodium salt (FSS) was prepared in methanol. The solution of the FSS was homogenized for 2 hour by mixing with rotation before the deposition. Then, the film of the FSS was prepared by casting the solution on Al metal with subsequent drying [18].

The ohmic contact with FSS layer was formed by Au electrode having a high work function  $\phi_B$ =5.47 eV [6]. The standard geometry of diode is shown in Fig.1. The current–voltage (I-V) measurements were performed with 2400 Keithley sourcemeter and GPIB data transfer card for current-voltage measurements. The capacitance-voltage (C-V) measurements were performed by use of HIOKI 3532-50 LCR.



Fig. 1 Schematic structure of the Al/p-FSS Schottky diode.

#### 3. Results and discussion

### 3.1. Current-voltage (I-V) characteristics of the Al/p-FSS Schottky diode

The current-voltage characteristic of the Al/p-FSS Schottky diode is shown in Fig. 2.



#### Fig. 2. Forward and reserve current curve of the Al/p-FSS Schottky diode.

The diode shows a rectification effect due to Schottky contact, which was formed at the Al/p-FSS. Current transport in Schottky diodes is defined by thermoionic emission theory given by [7-8]

$$I = I_0 \left( \exp(\frac{qV}{nkT}) - 1 \right) \tag{1}$$

where T is the temperature, n is the ideality factor  $\mbox{ and } I_o$  is the saturation current given by

$$I_O = AA^* T^2 \exp\left(-\frac{q\phi_{bO}}{kT}\right) \tag{2}$$

where A is the contact area, A\* is the Richardson constant (120 A.cm<sup>-2</sup>.K<sup>-2</sup> for free electron), and  $\phi_{bo}$  is the barrier height and n is the ideality factor and is equal to 1 for this mechanism. The n ideality factor of Al/p-FSS/Au diode was obtained from the slope of the straight linear region of forward bias InI-V characteristic by the equation,

$$n = \frac{q}{kT} \frac{dV}{d(\ln I)} \tag{3}$$

and the obtained n value is 3.32. This suggests that a deviation from ideal behavior was observed and so thermoionic emission theory is ruled out for Al/P-FSS/Au diode, i.e, I-V curve of the diode can not be fit by Eq.1. The non-ideal behavior can be due to series resistance, interface layer and inhomogeneous Schottky barrier height [9]. Eq.1 can be modified due to the series resistance as [10],

$$I_1 = I_{o1} \exp \frac{q(V - IR_s)}{nkT} \left(1 - \exp \frac{q(V - IR_s)}{nkT}\right)$$
(4)

and

$$I_{o1} = AA^*T^2 \exp\left(-\frac{q(\phi_{b-\Delta\phi})}{kT}\right)$$
(5)

The barrier height,  $\phi_{bo}$  in Eq.1 can be rewritten as

$$\phi_b = \phi_{bo} - \Delta \phi - \beta V \tag{6}$$

where  $\phi_b$  is the effective Schottky barrier height,  $\beta$  is a constant and  $\Delta \phi$  is an reduce amount in Schottky effect given by [10]

$$\Delta \phi = \left[ \frac{q^3 N_A}{8\pi^2 \varepsilon_s^2} \left( \phi_b - V - \xi - \frac{kT}{q} \right) \right]^{1/4} \tag{7}$$

where  $\zeta$  is the energy difference between the Fermi level and the bottom of the conduction band or top of the valence band. The values of I<sub>o</sub>, and  $\phi_B$  were found to be  $4.36 \times 10^{-7}$  A and 0.72 eV, respectively. The obtained n value confirms that the Al/P-FSS diode is metal-insulatorsemiconductor (MIS) configuration rather than an ideal Schottky diode. The various models have been developed to determine the series resistance effect. We used method developed by Cheung and et al. to the obtain the diode parameters. The Cheung's method is expressed by the following relations [11],

$$\frac{dV}{d\ln I} = n\frac{kT}{q} + IR_s \tag{8}$$

and

$$H(I) = V - n \frac{kT}{q} \ln \left(\frac{I}{AA^*T^2}\right)$$
(9)

where H(I) is written as,

$$H(I) = n\phi_B + IR_s \tag{10}$$

Figs. 3 and 4 show the curves associated with these relations. The slope and intercept of dV/dln(I)-I plot will give nkT/q and R<sub>s</sub>, respectively. The n and R<sub>s</sub> values were found to be 3.05 and 7.72 k $\Omega$ , respectively (Fig. 3). The plot of H(I)-I will give a straight line whose slope and intercept are n $\phi_B$  and Rs. The  $\phi_B$  and R<sub>s</sub> values from the Fig. 4 were calculated as 0.72 and 7.74 k $\Omega$ , respectively.



Fig. 3. Plot of dV/dln(I) vs I for the Al/p-FSS Schottky diode.



Fig. 4. Plot of H(I) vs I for the Al/p-FSS Schottky diode.

The obtained series resistance values are in agreement with each other due to consistency of Cheung method. Interfacial layer causes a voltage drop across the interface. The bias dependence on the voltage drop  $V_i$  across interfacial layer is expressed by [12,13],

$$V_i = (1 - \frac{1}{n})V \tag{11}$$

The effect of series resistance is taken into account by substituting V in Eq. 11 with (V-IR<sub>S</sub>). After arranging the Eq. 11, it gives,

$$V_i = (1 - \frac{1}{n})(V - IR_S)$$
(12)

The values of  $V_i$  were calculated using Eq. 11. In order to obtain the voltage drop across depletion layer  $V_D$ , voltage obtained from Eq. 11 should be subtracted from the total value of applied forward voltage,

$$V_D = V - V_i \tag{13}$$

The curves of lnI v.s V were reported for obtained  $V_i$ and  $V_D$  values (Fig. 5) to indicate effect of interface layer on parameters of the diode. The n and  $\phi_B$  values of Al/P-FSS diode were calculated from the lnI- $V_D$  plot and were found to be 1.35 and 0.71 eV, respectively. The obtained values are lower than equivalent values obtained previously without considering effect of the presence of interfacial layer.



Fig. 5. Plots of the forward and reserve currents v.s  $V_i$ and  $V_D$  voltages for the Al/p-FSS diode.

## **3.2.** The capacitance-voltage (C-V) characteristics of the Al/p-FFS Schottky diode

The depletion layer for a Schottky diode is given by [7-8]

$$\frac{1}{C^2} = \frac{2(V_{bi} + V)}{A^2 \varepsilon_s q N_a} \tag{14}$$

where  $V_{bi}$  is the built-in potential, which originates from the difference of work functions between metal and semiconductor,  $\varepsilon_s$  is the dielectric constant of semiconductor and  $N_a$  is the acceptor concentration given by [14]

$$N_A = \left(\frac{2}{q\varepsilon_s A^2}\right) \frac{dV}{dC^{-2}} \tag{15}$$

The variation of  $C^{-2}$  with V for the diode is shown in Fig. 6. N<sub>a</sub> was determined from the slope of Fig. 6 using Eq.15 and was found to be  $1.69 \times 10^{10}$  cm<sup>-3</sup>.



Fig. 6. Plot of  $C^2$  vs V plot of Al/p-FSS diode.

The value of  $V_{bi}$  was determined from the intercept of  $C^2$  vs V plot and was found to be 0.52 V. The barrier height of a Schottky diode is given by

$$\phi_{b(C-V)} = V_{bi} + \frac{kT}{q} \ln\left(\frac{N_v}{N_a}\right) \tag{16}$$

where  $N_a$  is the concentration of ionized acceptors given by [15]

$$N_a = N_v \exp\left(\frac{V_p}{kT}\right) \tag{17}$$

and

$$N_{v} = 4.83 \times 10^{15} \left( \frac{m_{h}^{*}}{m_{o}} \right) T^{3/2} \text{ cm}^{-3}$$
(18)

where  $N_v$  is the density of states in valence band of FSS,  $m_h^*$  is the effective mass of holes  $m_o$  is the stand mass of electron.  $N_v$  value for FSS at 298 K was found to be 2.42x10<sup>19</sup> cm<sup>-3</sup> using Eq.18. The  $\phi_{b(C-V)}$  value was calculated using the  $V_{bi}$  and  $V_p$  values and was found to be 1.05 eV. The barrier height obtained from the C-V measurements is higher than obtained from the I-V measurements. The difference between  $\phi_b(I-V)$  and  $\phi_b(C-V)$  can be due to interfacial layer, excess capacitance and barrier inhomogenity [15].

#### 3.3. Interface state density properties of Al/p-FSS Schottky diode

The ideality factor for metal-insulator-semiconductor (MIS) can be expressed as [16],

$$n = 1 + \frac{\varepsilon_i}{\delta} \left( \frac{\varepsilon_s}{w} + qN_{ss} \right)$$
(19)

where  $N_{ss}$  is the density of the interface states,  $\varepsilon_i$  is the dielectric constant of the interfacial layer, w is the space charge width and  $\delta$  is the thickness of interfacial layer and  $\varepsilon_i/\delta$  can be obtained from the following relation [17],

$$\frac{\varepsilon_i}{\delta} = \left[\frac{\varepsilon_s}{w} \left(\frac{1}{\alpha} - 1\right)\right] \tag{20}$$

where  $\alpha = (kT/q)(dlnI/dV)$  is the slope of reverse bias I-V characteristic.  $\epsilon_s/w$  was determined from the reverse current curve using Eq. 20 and was found to be 9.352. The insulator layer thickness  $\delta$  was obtained from the following relation [7]

$$Cox = \frac{\varepsilon_i \varepsilon_0}{\delta} A \tag{21}$$

where  $C_{ox}$  is the insulator layer capacitance and  $\epsilon_i/\delta$  was found to be 64.87. The energy of the interface states can determined as [12],

$$E_{SS} - E_V = q(\phi_e - V) \tag{22}$$

where  $E_{ss}$  is the energy corresponding to the bottom of the conduction band at the surface of the semiconductor and  $\phi_e$  is the effective barrier height depends on applied voltage due to an interfacial layer given by

$$\phi_e = \phi_B + \left(1 - \frac{1}{n}\right) V \tag{23}$$

where n is dependent on voltage applied.  $N_{ss}$  values were obtained via the Eq. 19. The  $N_{ss}$  dependence on  $E_{SS}-E_V$  is shown in Fig. 7. It is seen that  $N_{ss}$  value decreases with increasing  $E_{SS}-E_V$  value. The shape of the density distribution of the interface states is in the range of  $E_{SS}$ -0.02 eV to  $E_{SS}$ -1.2 eV. At higher voltages, the decrease in diode current is due to interface states and series resistance effect.



Fig. 7. Variation of  $N_{ss}$  values with  $E_{ss}$ - $E_v$  for Al/p-FSS Schottky diode.

#### 4. Conclusions

Electronic and interface state properties of the Al/p-FSS diode were investigated by current-voltage and capacitance-voltage analyses. The electronic parameters such as barrier height ( $\phi_B$ =0.72 eV), ideality factor (n=3.05) and series resistance (7.73 k $\Omega$ ) of the Schottky diode were determined by performing different plots. The  $\phi_{B(C-V)}$  value obtained capacitance-voltage measurements is 1.05 eV. The barrier height ( $\phi_B$ =1.05 eV) obtained from the C-V measurements is higher than obtained ( $\phi_B$ =0.72 eV) from the I-V measurements. The ideality factor confirms that the Al/P-FSS device is a metal-insulator-semiconductor Schottky diode. The shape of the density distribution of the interface states is in the range of E<sub>SS</sub>-0.02 eV to E<sub>SS</sub>-1.21 eV.

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